

# BCR16CS-16LB

800V-16A-Triac  
Medium Power Use


R07DS0226EJ0200  
Rev.2.00  
Oct 19, 2015

## Features

- $I_{T(RMS)}$  : 16 A
- $V_{DRM}$  : 800 V
- $I_{FGTI}$ ,  $I_{RGTI}$ ,  $I_{RGT III}$  : 30 mA
- The product guaranteed maximum junction temperature of 150°C
- Non-Insulated Type
- Planar Passivation Type


## Outline

RENESAS Package code: PRSS0004AE-B  
(Package name: LDKPAK(S)-(1) )

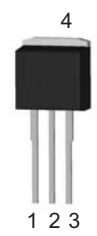


1. T<sub>1</sub> Terminal  
2. T<sub>2</sub> Terminal  
3. Gate Terminal  
4. T<sub>2</sub> Terminal

RENESAS Package code: PRSS0004AS-A  
(Package name: TO-263)



RENESAS Package code: PRSS0004AR-A  
(Package name: TO-262)



## Applications

Contactless AC switch, light dimmer, electronic flasher unit, hair drier, control of household equipment such as TV sets, stereo systems, refrigerator, washing machine, infrared kotatsu, carpet, electric fan, solenoid driver, small motor control, solid state relay, copying machine, electric tool, electric heater control, and other general purpose control applications

## Maximum Ratings

Parameter	Symbol	Voltage class	Unit
		16	
Repetitive peak off-state voltage <sup>Note1</sup>	$V_{DRM}$	800	V
Non-repetitive peak off-state voltage <sup>Note1</sup>	$V_{DSM}$	960	V

Parameter	Symbol	Ratings	Unit	Conditions
RMS on-state current	$I_{T(RMS)}$	16	A	Commercial frequency, sine full wave 360° conduction, $T_c = 125^\circ\text{C}$ <sup>Note3</sup>
Surge on-state current	$I_{TSM}$	160	A	60Hzsinewave 1 full cycle, peak value, non-repetitive
$I^2t$ for fusing	$I^2t$	106.5	$\text{A}^2\text{s}$	Value corresponding to 1 cycle of half wave 60Hz, surge on-state current
Peak gate power dissipation	$P_{GM}$	5	W	
Average gate power dissipation	$P_{G(AV)}$	0.5	W	
Peak gate voltage	$V_{GM}$	10	V	
Peak gate current	$I_{GM}$	2	A	
Junction temperature	$T_j$	- 40 to +150	$^\circ\text{C}$	
Storage temperature	$T_{stg}$	- 40 to +150	$^\circ\text{C}$	
Mass	—	1.3	g	Typical value

Notes: 1. Gate open.

## Electrical Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test conditions
Repetitive peak off-state current	$I_{DRM}$	—	—	2.0	mA	$T_j = 150^\circ\text{C}$ , $V_{DRM}$ applied
On-state voltage	$V_{TM}$	—	—	1.5	V	$T_c = 25^\circ\text{C}$ , $I_{TM} = 25\text{ A}$ , Instantaneous measurement
Gate trigger voltage <sup>Note2</sup>	I	$V_{FGTI}$	—	—	1.5	$T_j = 25^\circ\text{C}$ , $V_D = 6\text{ V}$ , $R_L = 6\ \Omega$ , $R_G = 330\ \Omega$
	II	$V_{RGTI}$	—	—	1.5	
	III	$V_{RGTIII}$	—	—	1.5	
Gate trigger current <sup>Note2</sup>	I	$I_{FGTI}$	—	—	30	$T_j = 25^\circ\text{C}$ , $V_D = 6\text{ V}$ , $R_L = 6\ \Omega$ , $R_G = 330\ \Omega$
	II	$I_{RGTI}$	—	—	30	
	III	$I_{RGTIII}$	—	—	30	
Gate non-trigger voltage	$V_{GD}$	0.2/0.1	—	—	V	$T_j = 125^\circ\text{C}/150^\circ\text{C}$ , $V_D = 1/2 V_{DRM}$
Thermal resistance	$R_{th(j-c)}$	—	—	1.4	$^\circ\text{C}/\text{W}$	Junction to case <sup>Note3 Note4</sup>
Critical-rate of rise of off-state commutating voltage <sup>Note5</sup>	$(dv/dt)_c$	10/1	—	—	$\text{V}/\mu\text{s}$	$T_j = 125^\circ\text{C}/150^\circ\text{C}$

Notes: 2. Measurement using the gate trigger characteristics measurement circuit.

3. Case temperature is measured on the  $T_2$  tab.

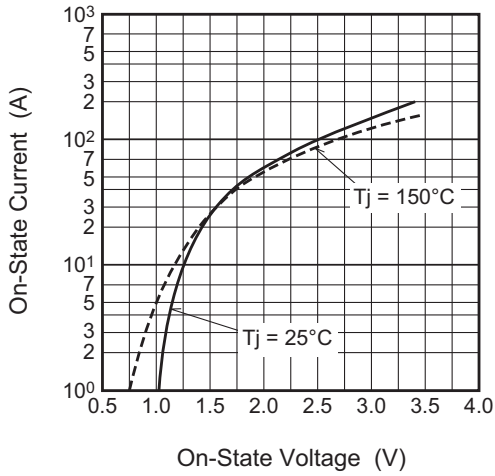
4. The contact thermal resistance  $R_{th(c-f)}$  in case of greasing is  $1.0^\circ\text{C}/\text{W}$ .

5. Test conditions of the critical-rate of rise of off-state commutating voltage is shown in the table below.

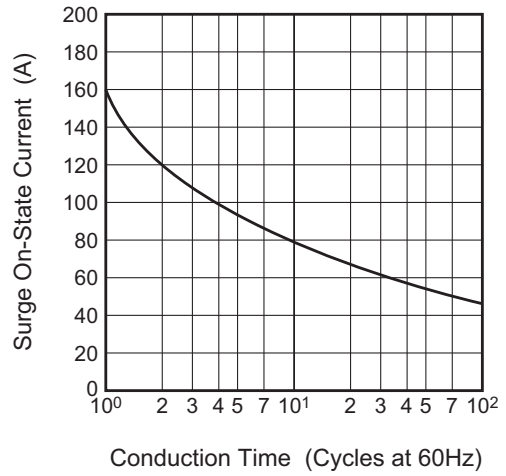
Test conditions	Commutating voltage and current waveforms (inductive load)
1. Junction temperature $T_j = 125^\circ\text{C}/150^\circ\text{C}$ 2. Rate of decay of on-state commutating current $(di/dt)_c = - 8.0\text{ A/ms}$ 3. Peak off-state voltage $V_D = 400\text{ V}$	

Performance Curves

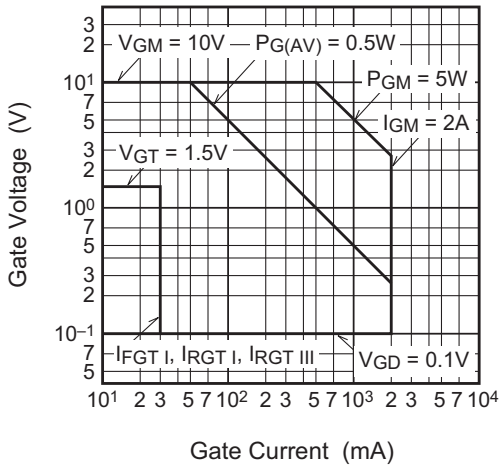
Maximum On-State Characteristics



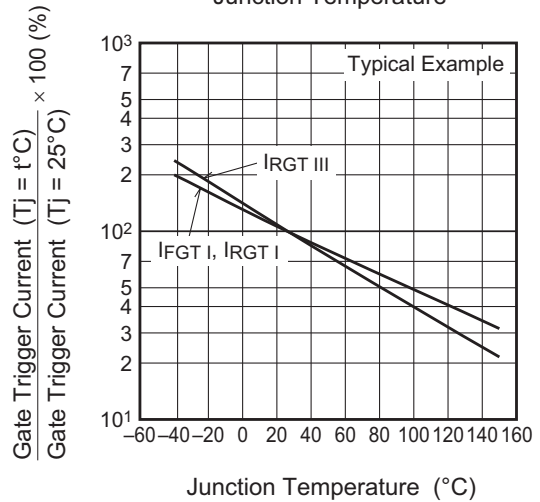
Rated Surge On-State Current



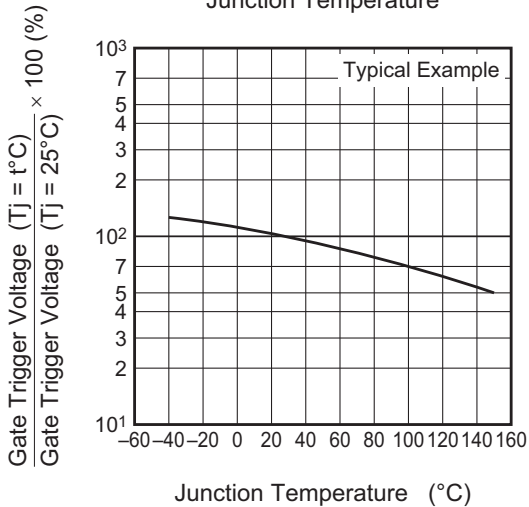
Gate Characteristics (I, II and III)



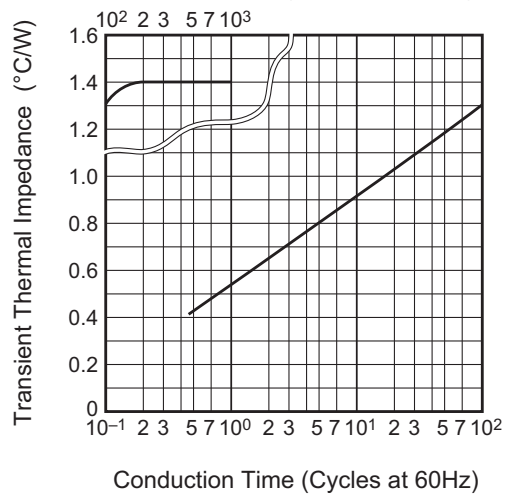
Gate Trigger Current vs. Junction Temperature

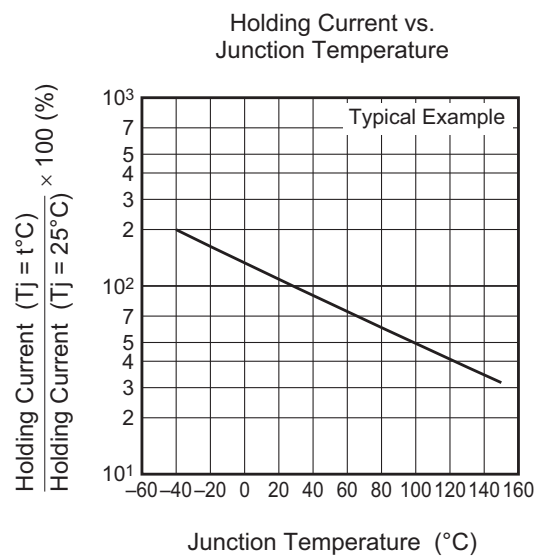
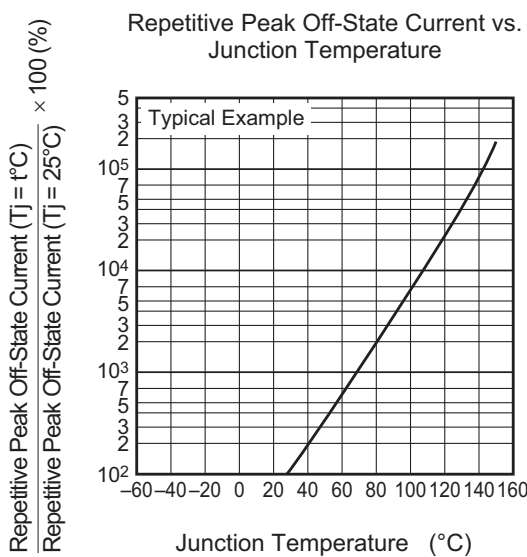
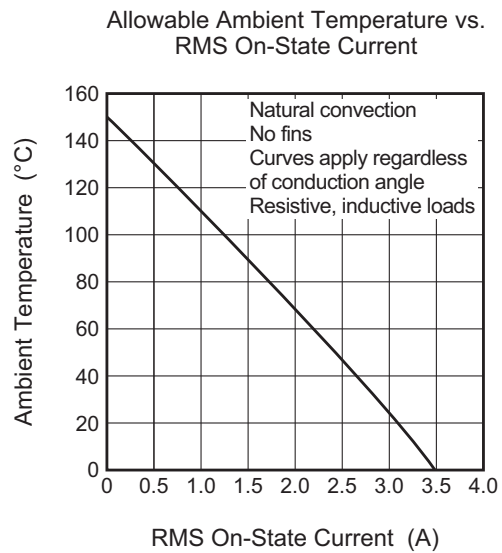
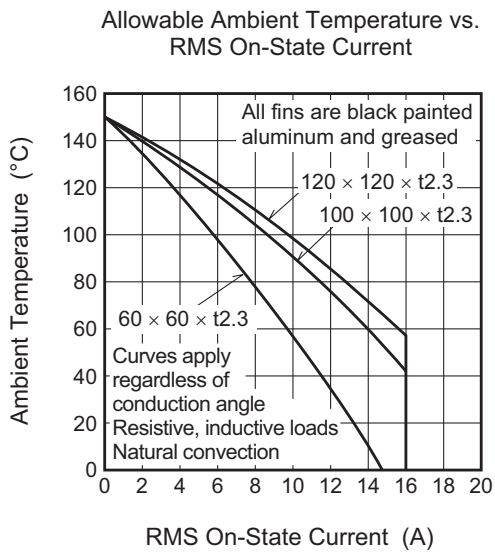
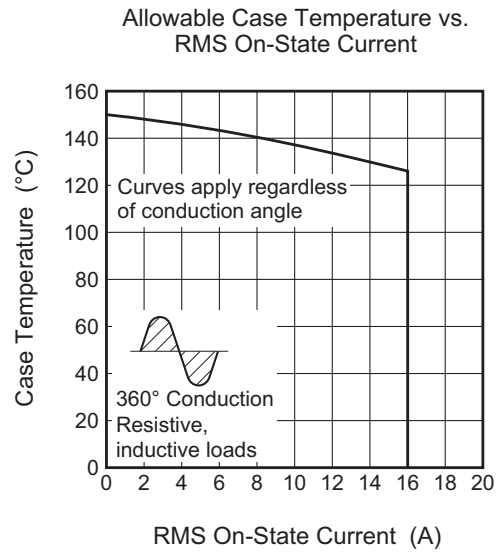
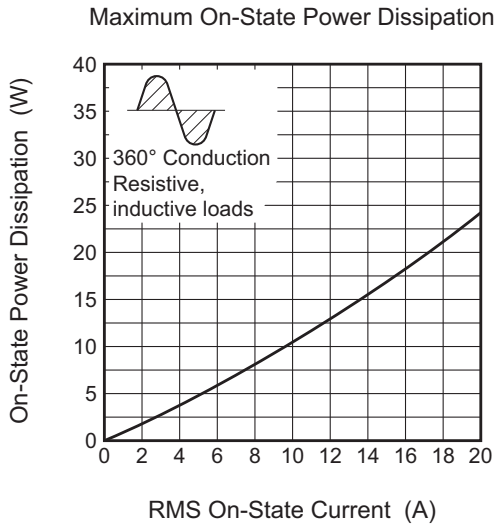


Gate Trigger Voltage vs. Junction Temperature

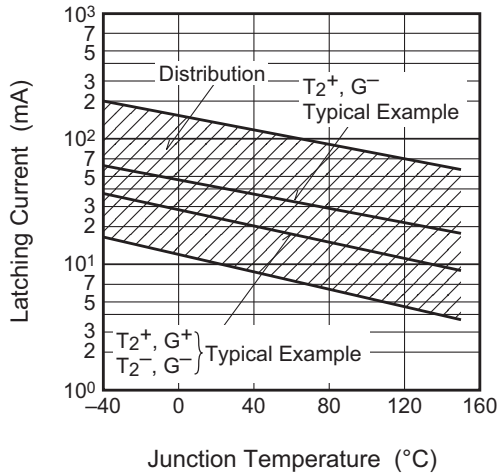


Maximum Transient Thermal Impedance Characteristics (Junction to case)

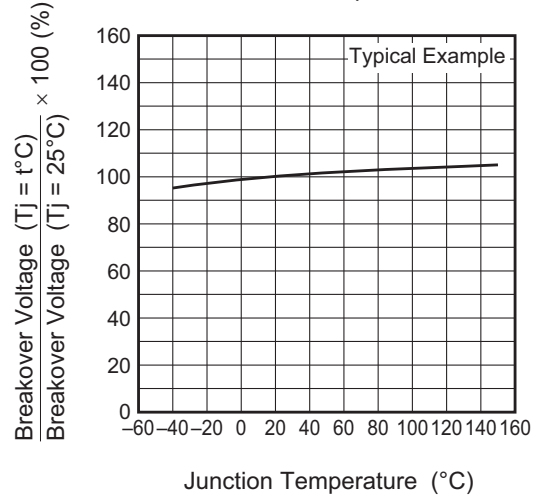




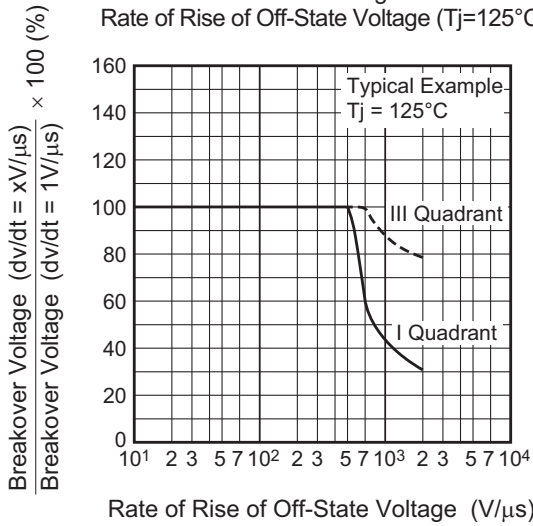
Latching Current vs. Junction Temperature



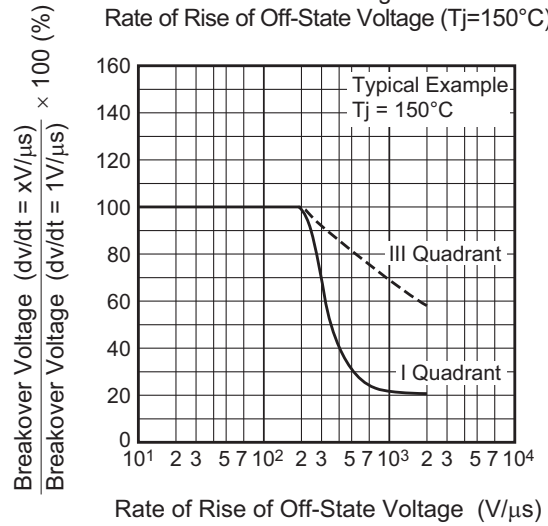
Breakover Voltage vs. Junction Temperature



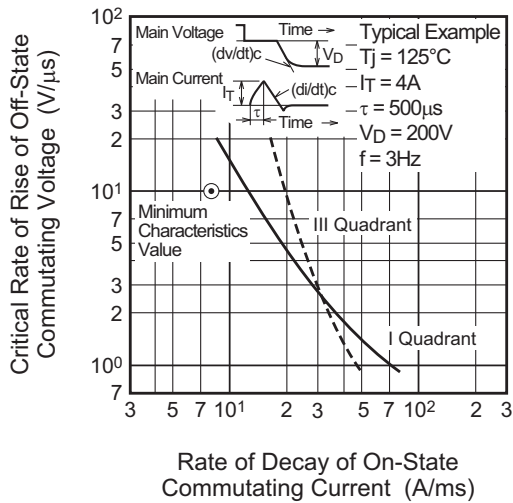
Breakover Voltage vs. Rate of Rise of Off-State Voltage (Tj=125°C)



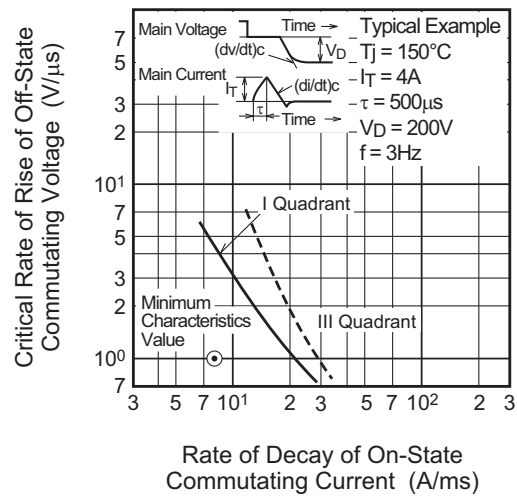
Breakover Voltage vs. Rate of Rise of Off-State Voltage (Tj=150°C)



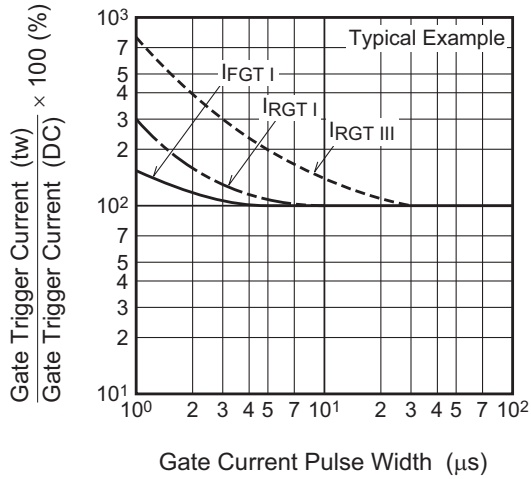
Commutation Characteristics (Tj=125°C)



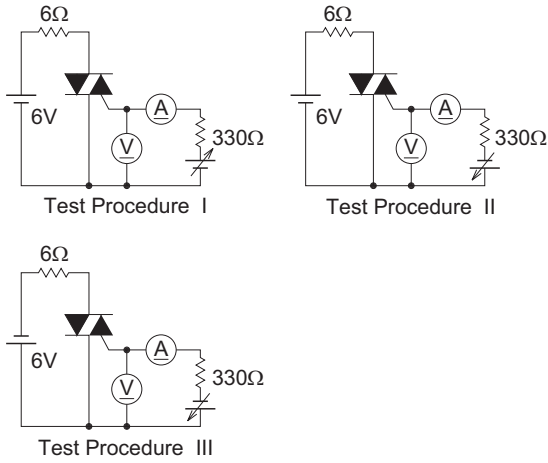
Commutation Characteristics (Tj=150°C)



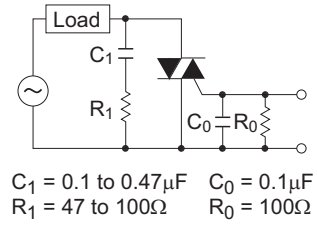
Gate Trigger Current vs. Gate Current Pulse Width



Gate Trigger Characteristics Test Circuits



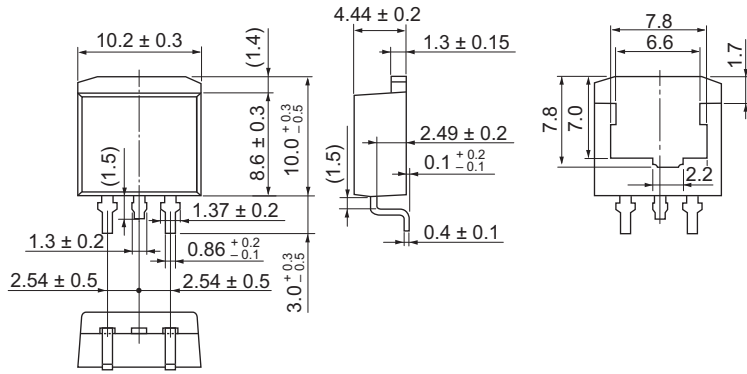
Recommended Circuit Values Around The Triac



Package Dimensions

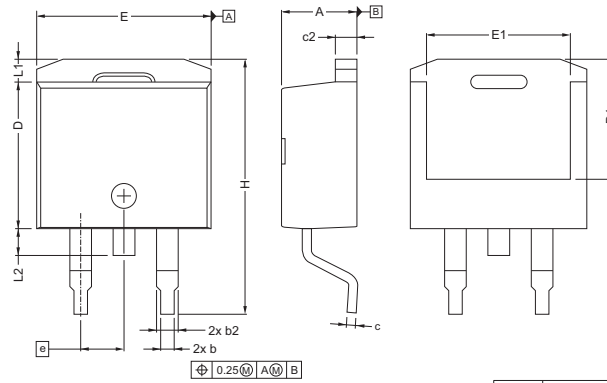
Package Name	JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
LDBPAK(S)-(1)	SC-83	PRSS0004AE-B	LDBPAK(S)-(1) / LDBPAK(S)-(1)V	1.30g

Unit: mm

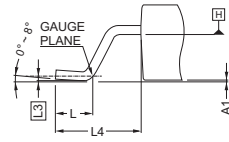
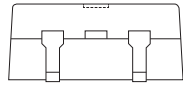


Package Name	JEITA Package Code	RENESAS Code	Previous Code	MASS (Typ) [g]
TO-263	—	PRSS0004AS-A	TO-263A	1.4

Unit: mm

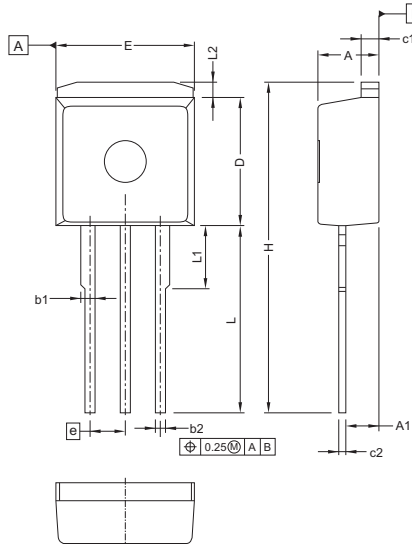


Reference Symbol	Dimensions in millimeters		
	Min	Nom	Max
A	4.20	—	4.60
A <sub>1</sub>	0.00	—	0.255
b	0.65	—	0.95
b <sub>2</sub>	1.12	—	1.42
c	0.381	—	0.737
c <sub>2</sub>	1.15	—	1.40
D	8.50	—	9.10
D <sub>1</sub>	6.90	—	7.50
E	10.05	—	10.65
E <sub>1</sub>	8.00	—	8.80
e	2.54 BSC		
H	15.00	—	15.60
L	1.90	—	2.50
L <sub>1</sub>	—	—	1.70
L <sub>2</sub>	—	—	1.78
L <sub>3</sub>	0.25 BSC		
L <sub>4</sub>	4.78	—	5.28



Package Name	JEITA Package Code	RENESAS Code	Previous Code	MASS (Typ) [g]
TO-262	—	PRSS0004AR-A	TO-262A	1.4

Unit: mm



Reference Symbol	Dimensions in millimeters		
	Min	Nom	Max
A	4.200	4.400	4.600
A <sub>1</sub>	2.050	2.400	2.750
b <sub>1</sub>	0.635	1.050	1.400
b <sub>2</sub>	0.640	0.750	0.880
c <sub>1</sub>	1.140	1.300	1.400
c <sub>2</sub>	0.330	0.500	0.600
D	8.500	9.250	9.650
E	9.650	10.000	10.370
e	2.54 BSC		
H	—	23.850	—
L	12.900	13.500	14.100
L <sub>1</sub>	—	4.550	4.800
L <sub>2</sub>	—	1.100	1.727

**Ordering Information**

<b>Orderable Part Number</b>	<b>Package</b>	<b>Packing</b>	<b>Quantity</b>	<b>Remark</b>
BCR16CS-16LB#BH0	TO-263	Tube	50 pcs.	
BCR16CS-16LBT1#BH0	TO-263	Embossed Tape	800 pcs.	Taping direction "T1"
BCR16CS-16LBA1#BH0	TO-262	Tube	50 pcs.	
BCR16CS-16LB#B00	LDBAK(S)-(1)	Tube	50 pcs.	Not Recommend for New Design
BCR16CS16LBT11#B00	LDBAK(S)-(1)	Embossed Tape	1000 pcs.	Not Recommend for New Design

Note : Please confirm the specification about the shipping in detail.

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